

LINEAR TECHNOLOGY MATERIALS DECLARATION

1t3050mpmse-3.3#trpbf

(Engineering Calculation)

MSOP-Exposed

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TOTAL MASS (g) : 0.035451

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.000928	1000000	26176.9589844		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.013845	975000	390538.78125		
		Iron (Fe)	7439-89-6	0.000341	24000	9618.90429688		
		Phosphorus (P)	7723-14-0	0.000004	300	112.831718445		
		Zinc (Zn)	7440-66-6	0.000010	700	282.079284668		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.014200	1000000	400552.59375		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000710	1000000	20028.3339844		
		External Plating Total:				0.000710	1000000	20028.3339844
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000086	1000000	2425.88208008		
Internal Plating Total:				0.000086	1000000	2425.88208008		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000474	750000	13370.5585938		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000158	250000	4456.85253906		
Die Attach Total:				0.000632	1000000	17827.4101562		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.002439	130000	68799.140625		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.015571	830000	439225.6875		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000657	35000	18532.609375		
		Carbon Black (C)	1333-86-4	0.000094	5000	2651.54541016		
		Encapsulation Total:				0.018761	1000000	529208.9375
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000134	1000000	3779.86254883		
					TOTAL MASS (g) :	0.035451		